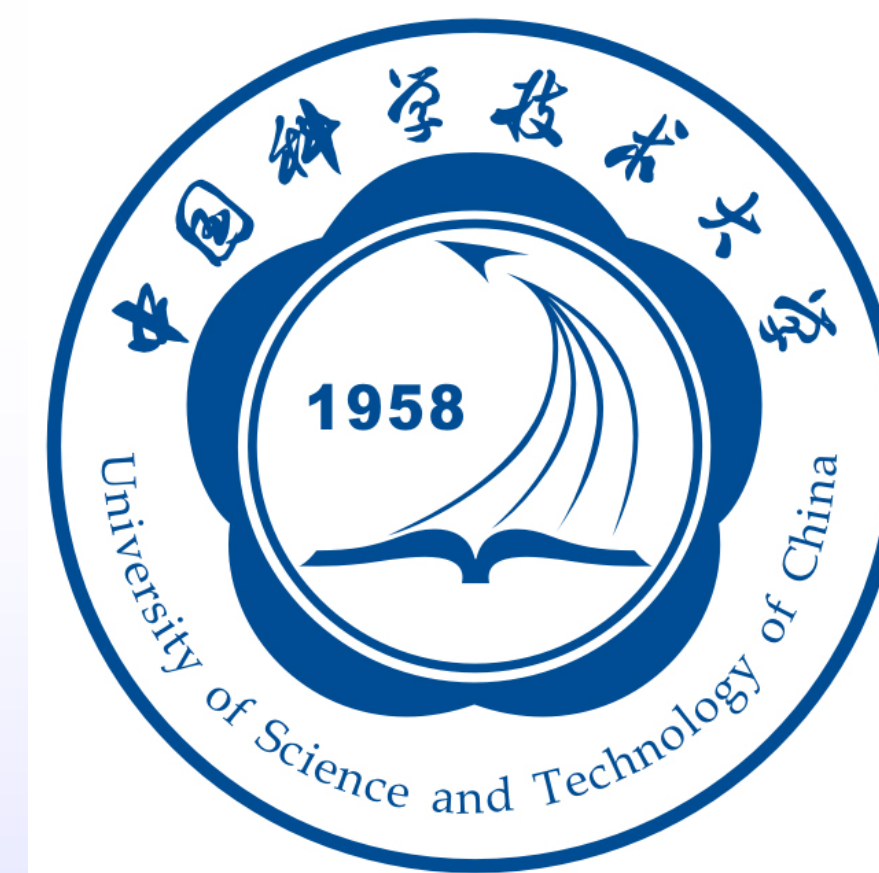


# Status of design and development of CEPC-DHCAI readout electronics

Yu Wang<sup>1,2</sup>, Daojin Hong<sup>1,2</sup>, Jianbei Liu<sup>1,2</sup>, Shubin Liu<sup>1,2</sup>, Changqing Feng<sup>1,2</sup>, Yi Zhou<sup>1,2</sup>

<sup>1</sup>University of Science and Technology of China

<sup>2</sup>State Key Laboratory of Particle Detection and Electronics



## Introduction

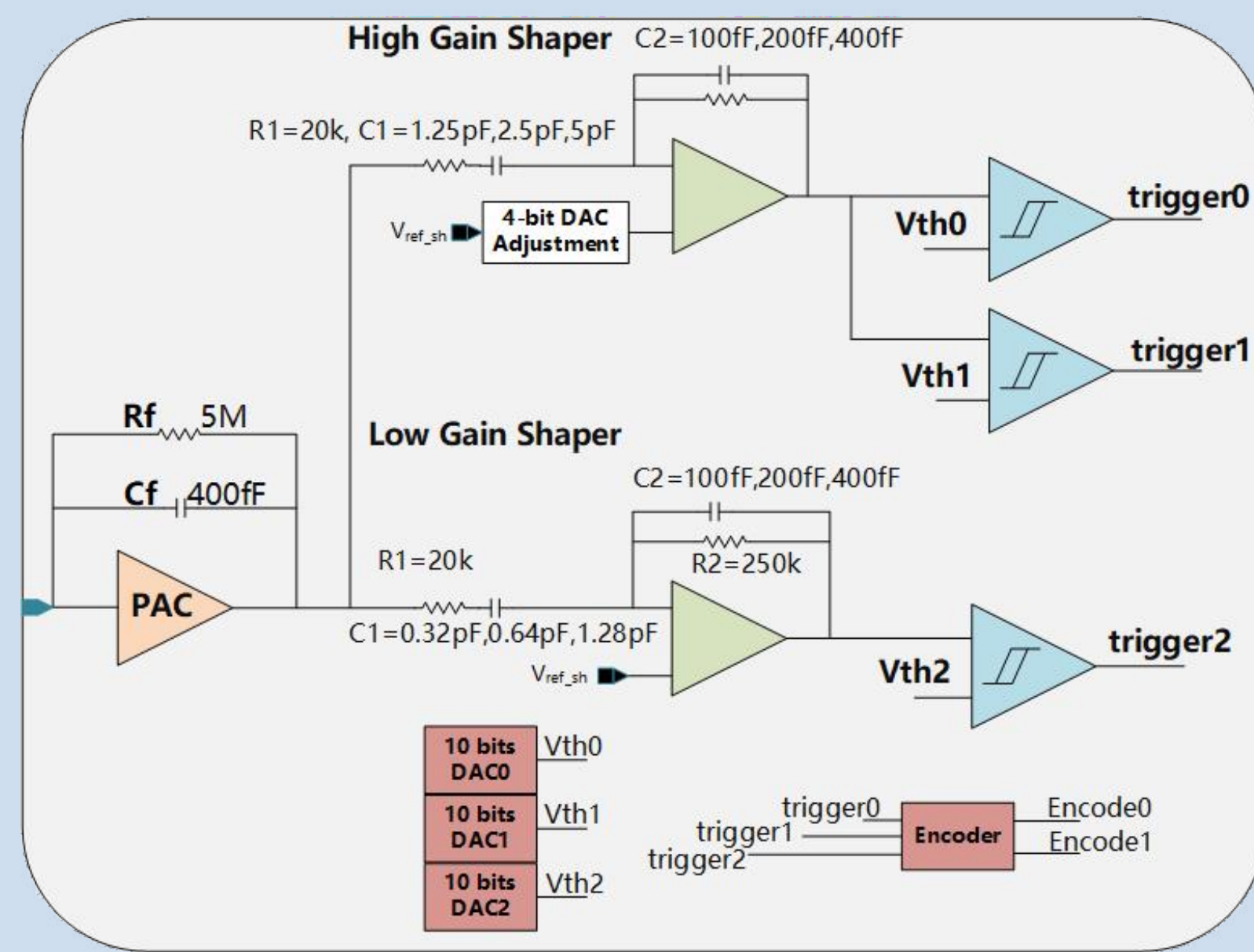
- The goal of this research is to provide a feasible readout scheme for CEPC DHCAI.
- As the active detector element of sampling calorimeter has finely segmented readout pads of  $1 \times 1\text{cm}^2$ , it's a real challenge to access huge mount data from calorimeter.
- In our research, a double layer GEM using self-stretching technique has been used. It consists of 3mm drift gap, 1mm transfer gap and 1mm induction gap and the effective area is  $30 \times 30\text{cm}^2$  with  $1 \times 1\text{cm}^2$  readout pads.
- The chip choosen to readout is a tri-thresholds ASIC called MICROROC (MICRO-mesh gaseous structure Read-Out Chip)

## MICROROC ASIC

MICROROC is a 64-channel Semi-Digital read-out chip, developed at IN2P3 by OMEGA/LAL. The package of MICROROC chip is TQFP which means the thickness is about 1.4mm. Each channel of the MICROROC chip has:

- A very low noise charge preamplifier, able to handle a dynamic range from 1 fC to 500fC
- Two different adjustable shaper. A high gain shaper for small signal and a low gain shaper for large signal
- Three comparators for tri-thresholds read-out
- A random access memory used as a digital buffer

The structure of the analog part is shown below:

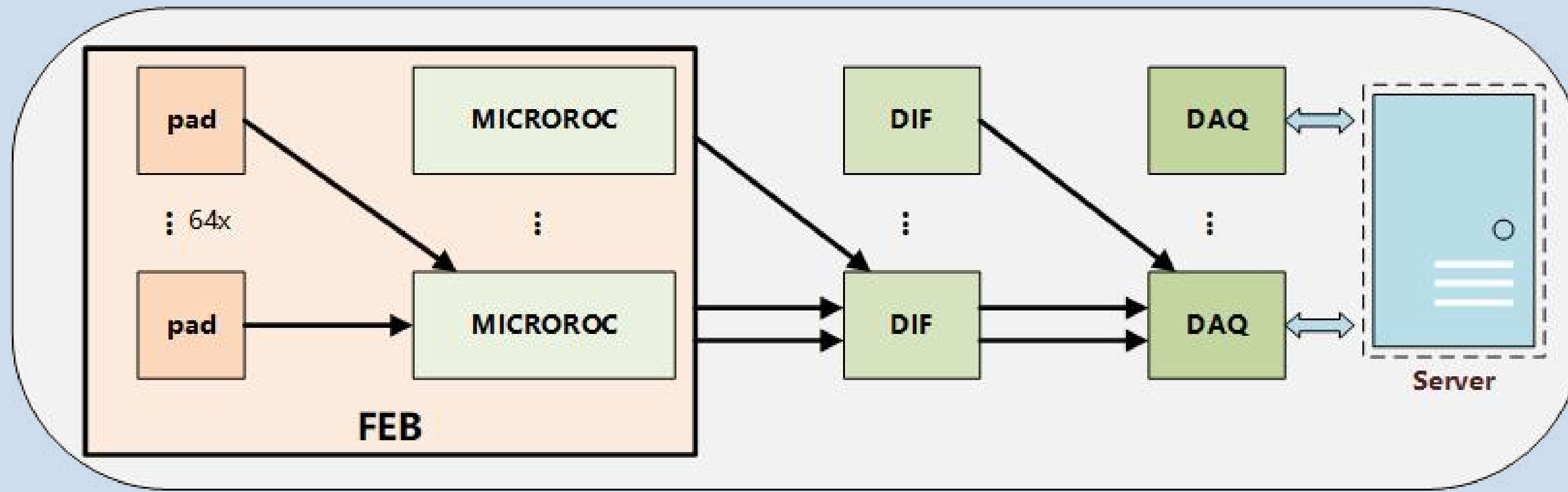


## Readout System Structure

The readout system is developed on SRS(Scalable Readout System), which means users can reuse the same system just changing the front-end board. The whole system includes flowing parts:

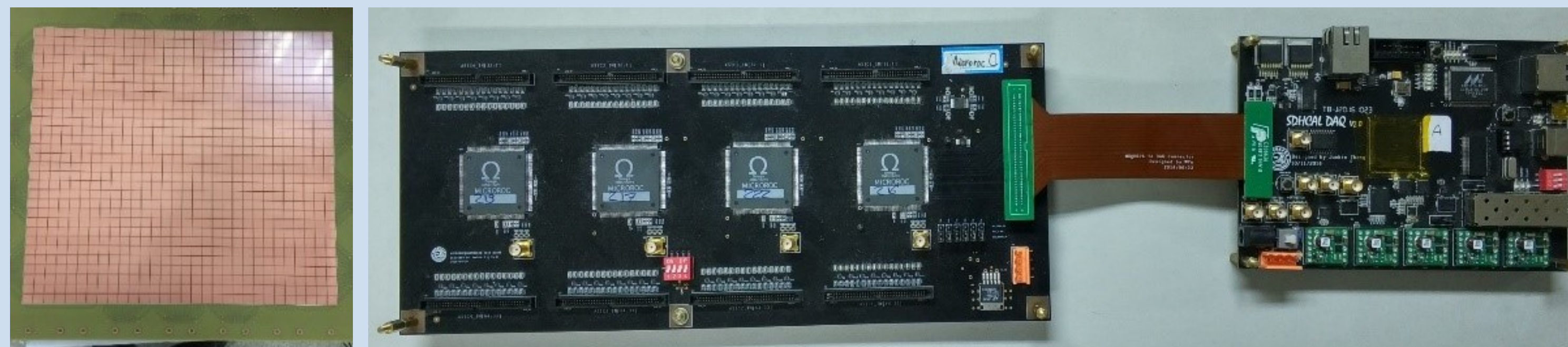
- FEB(Front-End Board):Combination of detector and readout ASIC
- DIF(Detector InterFace):Control the ASIC and read back data
- DAQ:Distribute clock and command. Gather data from DIF

The system structure of the hole system is shown below

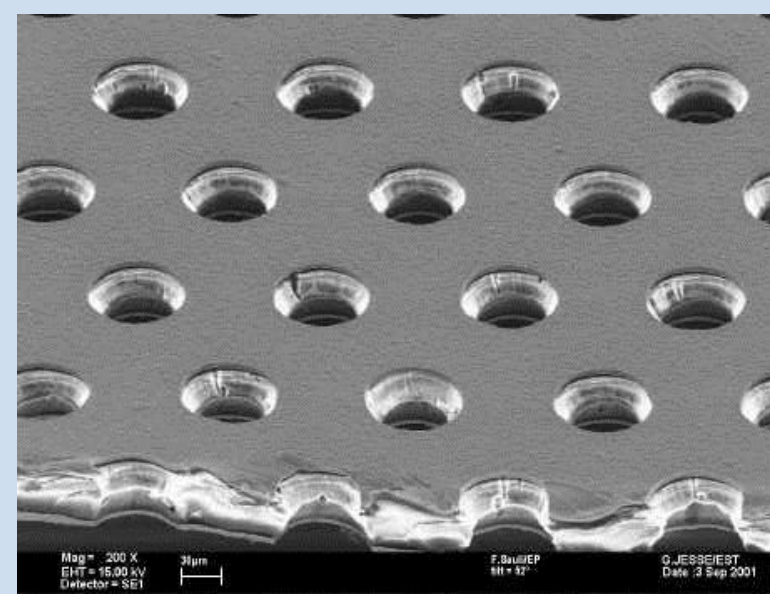


## Phase I Design and Test

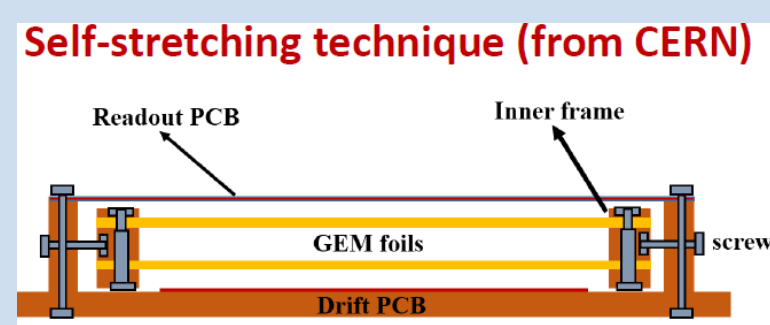
A "Phase I" design is completed to verify the readout structure and test the performance of MICRO-ROC. The front-end ASIC is separated from the detector plane. The system shown below contains the GEM detector, FEB and DIF.



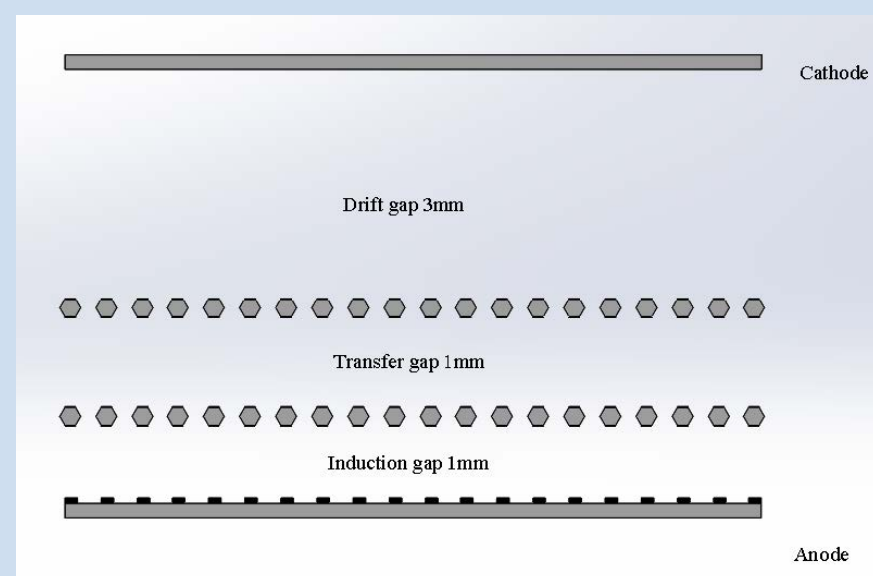
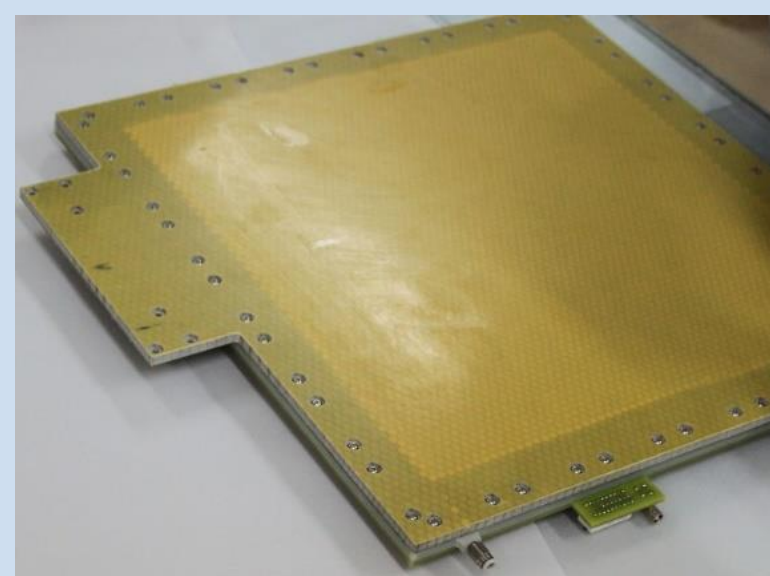
## GEM Detector



1. Cu:t =  $5\mu\text{m}$
2. Kapton:T =  $50\mu\text{m}$
3. Diameter: d =  $60\mu\text{m}$
4. D =  $80\mu\text{m}$
5. pitch:  $140\mu\text{m}$



1. Assembling process is easy and fast
2. No dead area inside the active area
3. Uniform gas flow
4. Detachable



## Next Step

## Conclusion

Total Conclusion

- d
- c
- b
- a
- d
- c
- b
- a

## Acknowledgements

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